

ABSTRACT

It is to provide an electronic component packaging container excellent in mechanical strength.

An electronic component packaging container which  
5 comprises a multilayer polyester sheet having a base  
layer comprising a polyethylene terephthalate type resin  
and a polycarbonate type resin and a surface layer  
comprising a polycarbonate type resin, formed on at least  
one side of the base layer, wherein the base layer  
10 contains from 70 to 97 wt% of the polyethylene  
terephthalate type resin and from 3 to 30 wt% of the  
polycarbonate type resin based on the total amount of the  
polyethylene terephthalate type resin and the  
polycarbonate type resin, and the thickness of the  
15 surface layer is from 10 to 30% of the total thickness.